

Investigation of Ion Induced Radiation Effects in Semiconductor Device IAEA CRP #11016 SNL's approach and potential contribution

Gyorgy Vizkelethy
Sandia National Laboratories

SNL collaborators: Robert Fleming, Edward Bielejec, Darwin Selkirk

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The goals of the CRP

- **To gain deeper understanding how defects are created by MeV ion irradiation in semiconductors and how they affect the electrical properties of these materials**
 - Use IBIC/TRIBIC and other non ion beam methods (such as DLTS, PL, electrical characterization) to characterize damage in various semiconductor materials created by MeV ions
 - Develop models for the ion beam interactions with semiconductor materials and for IBIC/TRIBIC in these devices and validate these models
 - Establish an experimental protocol for the the damage characterization to make us able to compare result from different laboratories



Pre characterization of the devices

■ Structural characterization (doping profiles, etc.)

- SIMS, spreading resistance, C-V

■ Electrical characterization

- C-V, I-V

■ Defect structure characterization

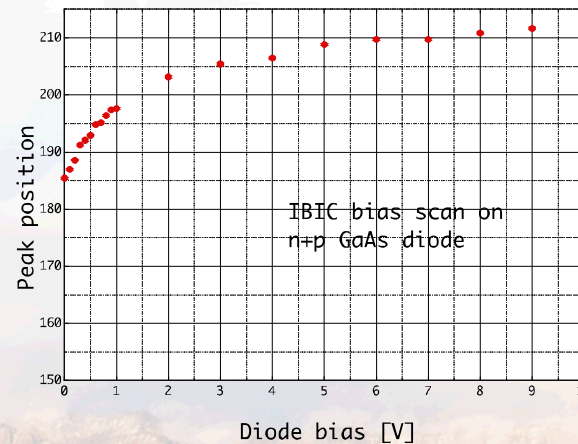
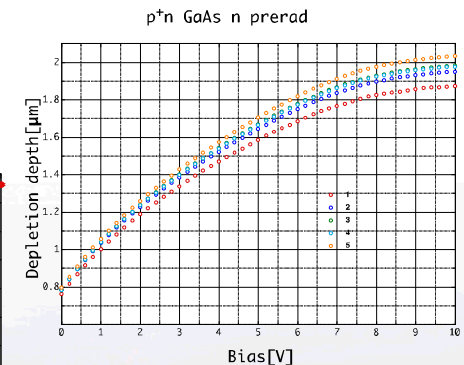
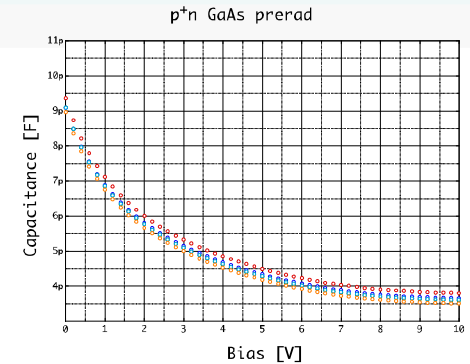
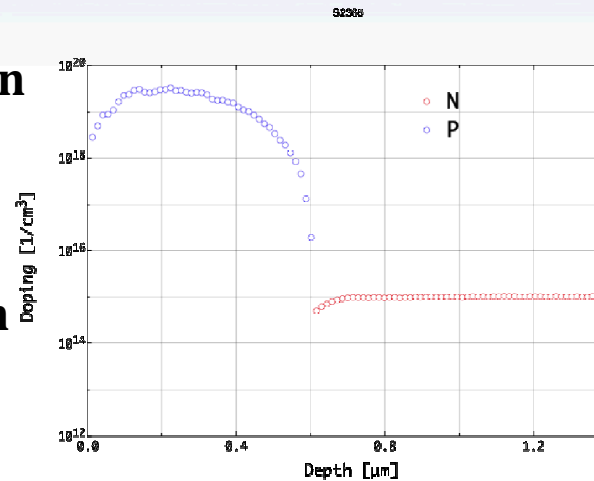
- DLTS

■ Other physical parameters

- For example PL for lifetime

■ IBIC/TRIBIC characterization

- MeV He or H beam



Irradiation

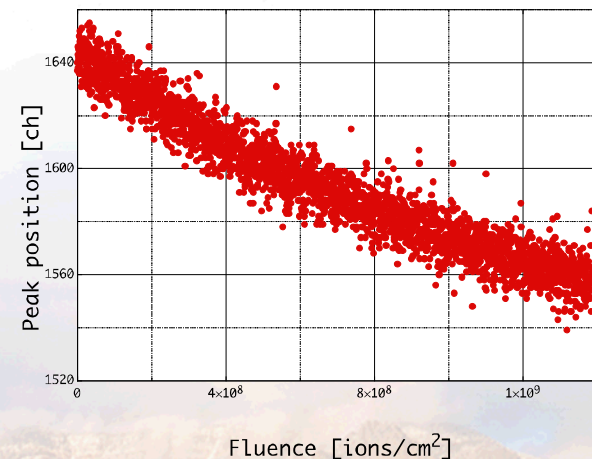
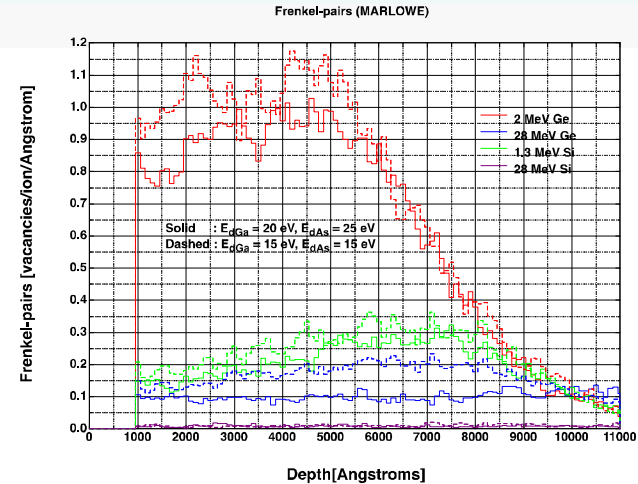
■ What kind of ion and what energy

- High energy ions produce uniform damage near the surface
- Low energy ions have damage peaked at end of range
- Heavy ions – clusters
- Light ions - point defect

■ Raster or broad beam

- Broad beam – possible uniformity problem, uses up a whole device
- Rastered – small area good for IBIC but bad for bulk techniques (DLTS)

■ In situ IBIC



Post characterization non-IBIC

I-V

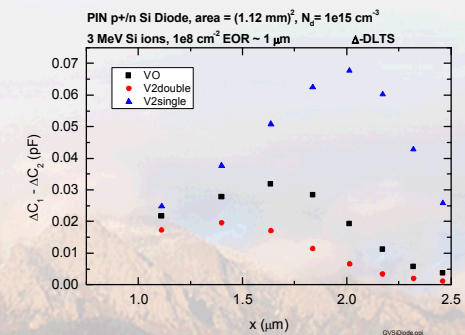
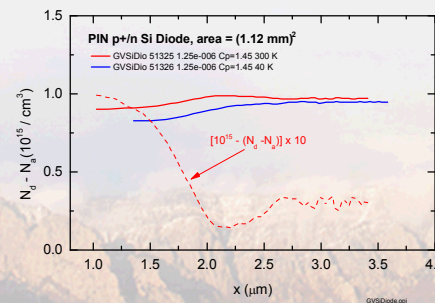
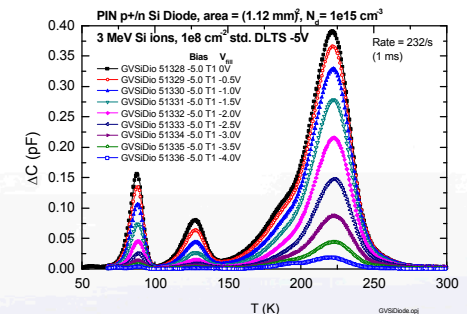
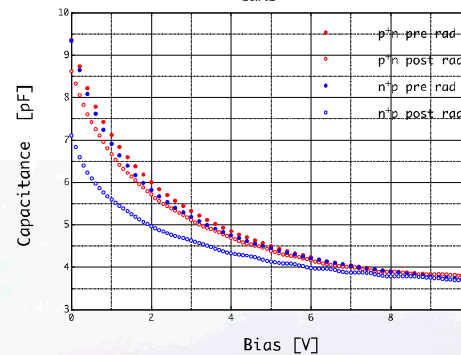
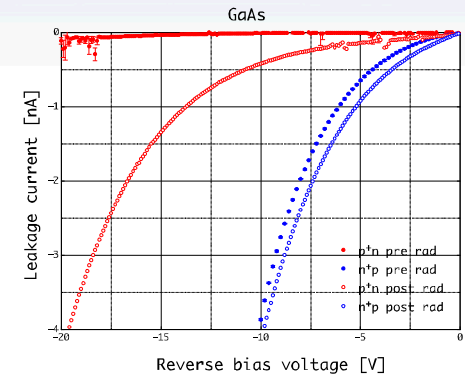
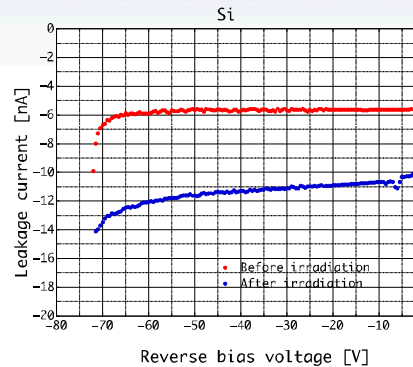
- Increasing leakage current

C-V

- Change in capacitance indicates charge trapped in defects

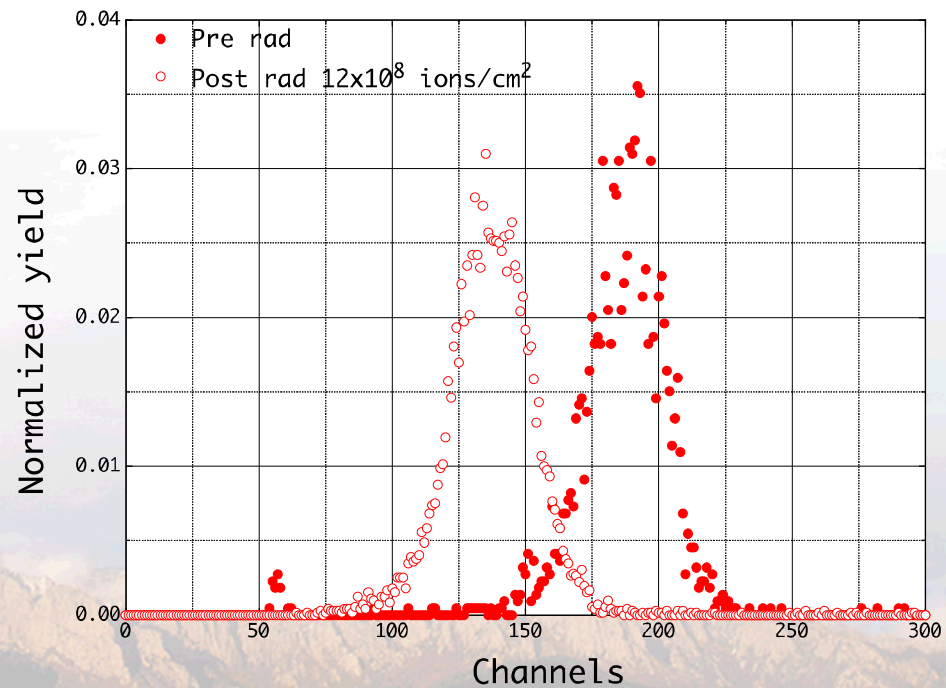
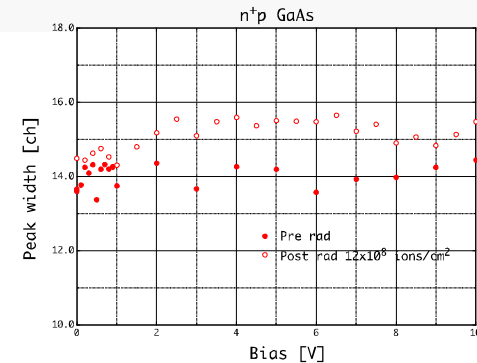
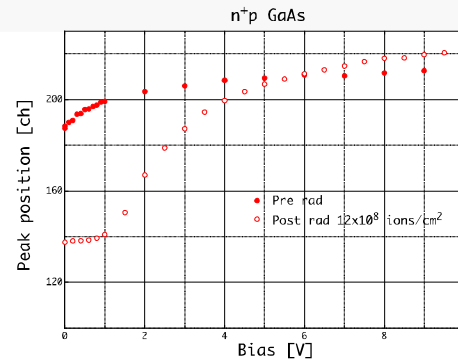
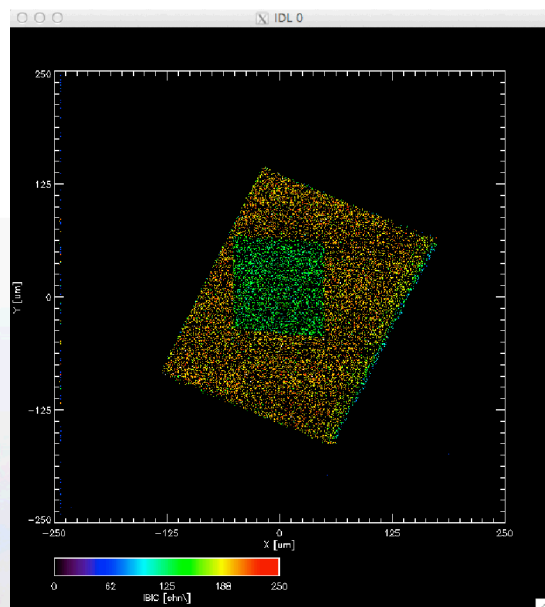
DLTS

- Identify defects, depth distribution, trapped charge



Post characterization IBIC

■ Changes in peak position, peak width, 2D maps





Modeling: Ion-Solid Interaction

■ Binary Collision Approximation Codes

- Can handle high energies, needs parameters (displacement energy)
 - ♦ MARLOWE: crystals, polycrystalline and amorphous materials, not user friendly but quite precise and sophisticated
 - ♦ SRIM: only amorphous materials, very easy to use, over estimates damage, good for quick calculations

■ Molecular Dynamics Codes

- Low energies and small crystals, but needs fewer parameters, more first principle approach than BCA
 - ♦ Most codes are home grown although there are some that are more widespread (for example SNL's LAMMPS)





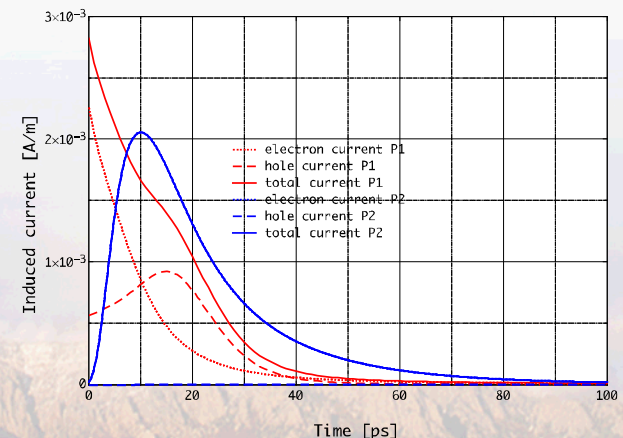
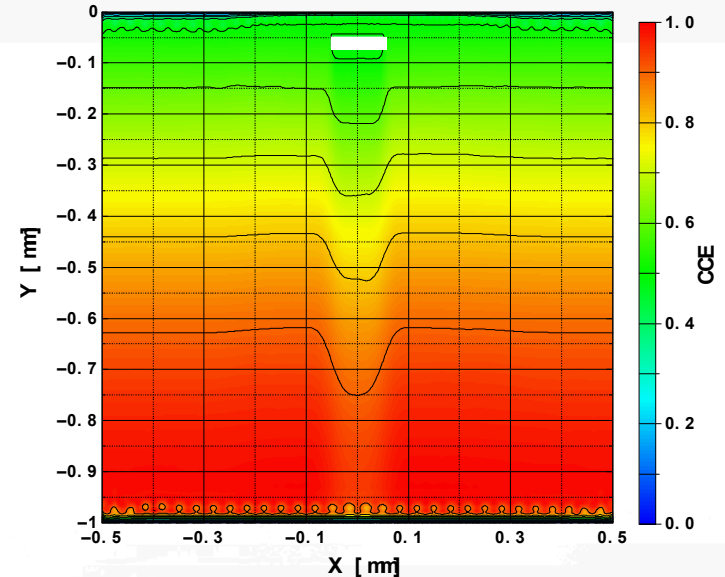
Modeling: Defect physics

- **Density Functional Theory (DFT) and its variations**
 - Calculates energy levels, etc.
- **Kinetic Monte-Carlo, Drift-Diffusion models**
 - Defect evolution



Modeling: IBIC/TRIBIC

- **Drift-diffusion model with stationary defects and application of Gunn's theorem (maybe the adjoint method when applicable)**
 - TCAD (expensive, no source code)
 - Some finite element software (COMSOL), needs to develop own model but more flexible
 - PISCES, or other codes to calculate electric fields





SNL's capabilities

- 6 MV tandem van de Graaff with a heavy ion microprobe (<1 μm) for IBIC/TRIBIC and irradiation
- 3 MV single ended Pelletron with light ion microprobe ($\sim 100\text{ nm}$) for IBIC/TRIBIC
- Several other implanters < 300 keV
- DLTS, PL, electrical characterization
- Modeling: MARLOWE, SRIM, COMSOL, > 80 CPU Linux cluster in the department, home grown 1D drift-diffusion code with defect evolution
- Available expertise (others than included in the project) for MD and DFT
- TEMs (one connected to the tandem) and SEMs (one on microbeam chamber) are available





Summary

The SNL team has the resources and expertise to successfully participate in the IAEA CRP #11016 and we are looking forward to collaborate with the other participants.

